



General Information

Series	SMD Auto X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable, Automotive Grade
RoHS	Yes
Termination	Tin
Typical Component Weight	1.21 mg
Shelf Life	78 Weeks

Dimensions

S	0.3mm MIN
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Packaging Specifications

Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	10000

Specifications

Capacitance	300 pF
Tolerance	5%
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+150°C
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Insulation Resistance	100 GOhms

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